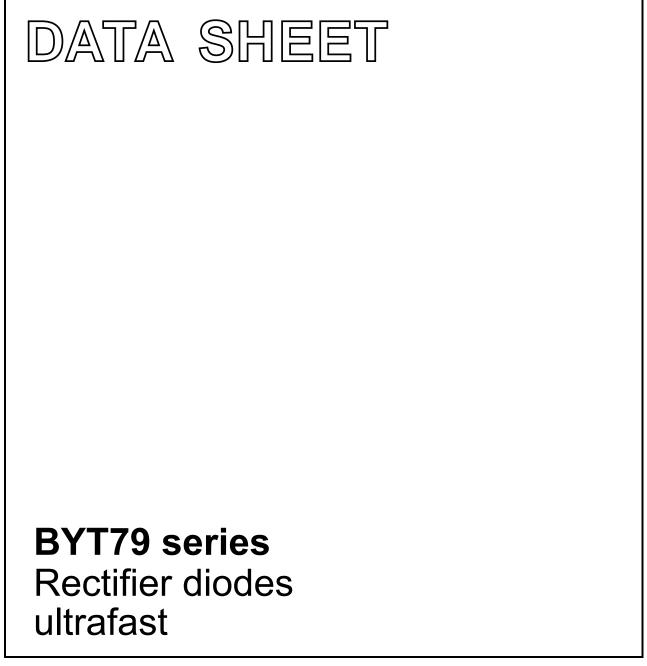
DISCRETE SEMICONDUCTORS



Product specification

September 1998



Product specification

BYT79 series

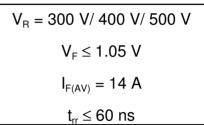
Rectifier diodes ultrafast

FEATURES

- · Low forward volt drop
- · Fast switching
- · Soft recovery characteristic
- High thermal cycling performance
- · Low thermal resistance

SYMBOL k а 2 1

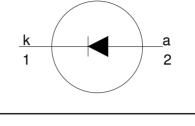
QUICK REFERENCE DATA



GENERAL DESCRIPTION

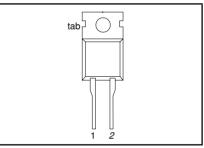
Ultra-fast, epitaxial rectifier diodes intended for use as output rectifiers in high frequency switched mode power supplies.

The BYT79 series is supplied in the conventional leaded SOD59 (TO220AC) package.



DESCRIPTION

SOD59 (TO220AC)



LIMITING VALUES

Limiting values in accordance with the Absolute Maximum System (IEC 134).

PINNING

PIN

1

2

tab

cathode

anode

cathode

SYMBOL	PARAMETER	CONDITIONS	MIN.	MAX.			UNIT
V _{RRM} V _R	Peak repetitive reverse voltage Continuous reverse voltage	BYT79 T _{mb} ≤ 147°C	-	-300 300 300	-400 400 400	-500 500 500	<<
I _{F(AV)} I _{FSM}	Average forward current ¹ Non-repetitive peak forward current.	square wave; $\delta = 0.5$; $T_{mb} \le 117$ °C t = 10 ms t = 8.3 ms sinusoidal; with reapplied	- -		14 130 143		A A A
T _{stg} T _i	Storage temperature Operating junction temperature	V _{RRM(max)}	-40 -		150 150		Û Û

THERMAL RESISTANCES

SYMBOL	PARAMETER	CONDITIONS	MIN.	TYP.	MAX.	UNIT
R _{th j-mb}	Thermal resistance junction to mounting base		-	-	2.0	K/W
R _{th j-a}		in free air.	-	60	-	K/W

¹ Neglecting switching and reverse current losses

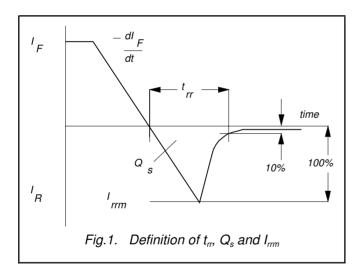
Rectifier diodes ultrafast

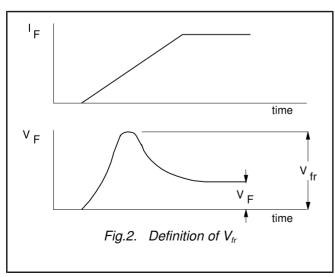
BYT79 series

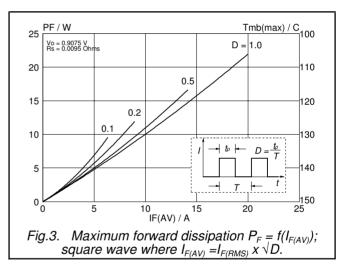
ELECTRICAL CHARACTERISTICS

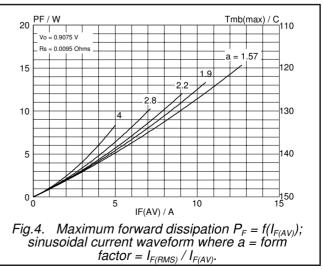
 $T_i = 25$ °C unless otherwise stated

SYMBOL	PARAMETER	CONDITIONS	MIN.	TYP.	MAX.	UNIT
V _F	Forward voltage	$I_{\rm F} = 15 \text{ A}; T_{\rm j} = 150^{\circ}\text{C}$	-	0.90	1.05	V
I _B	Reverse current	$V_{\rm F} = 30 \text{ A}$ $V_{\rm R} = V_{\rm RRM}$	-	1.17 5.0	1.38 50	ν μA
		$V_R^{T} = V_{RRM}^{T}$; $T_j = 100 \degree C$ $I_F = 2 \ A \ to \ V_R \ge 30 \ V$;	-	0.2	0.8 60	mΑ
Q _s	Reverse recovery charge	$I_{\rm F} = 2 \text{ A to } V_{\rm R} \ge 30 \text{ V},$ $ dI_{\rm F}/dt = 20 \text{ A}/\mu \text{s}$	-	50	60	nC
t _{rr}	Reverse recovery time	$I_F = 1 \text{ A to } V_R \ge 30 \text{ V};$ $dI_F/dt = 100 \text{ A/}\mu\text{s}$	-	50	60	ns
l _{rrm}	Peak reverse recovery current	$I_{\rm F} = 10 \text{ A to } V_{\rm B} \ge 30 \text{ V};$	-	4.0	5.2	А
V _{fr}	Forward recovery voltage	dI _F /dt = 50 A/μs; T _j = 100°C I _F = 10 A; dI _F /dt = 10 A/μs	-	2.5	-	V



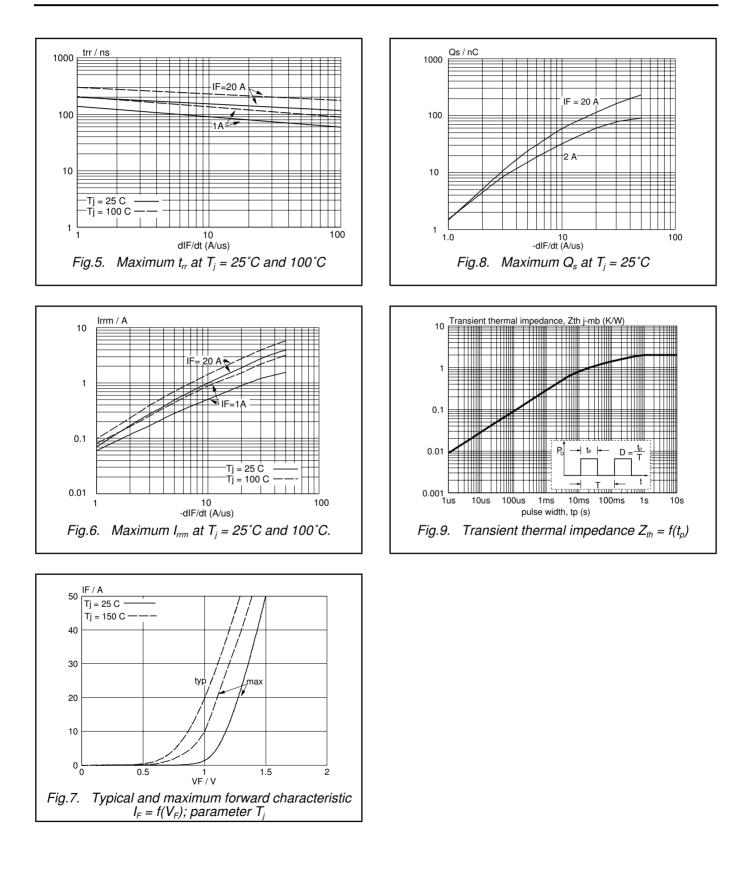






BYT79 series

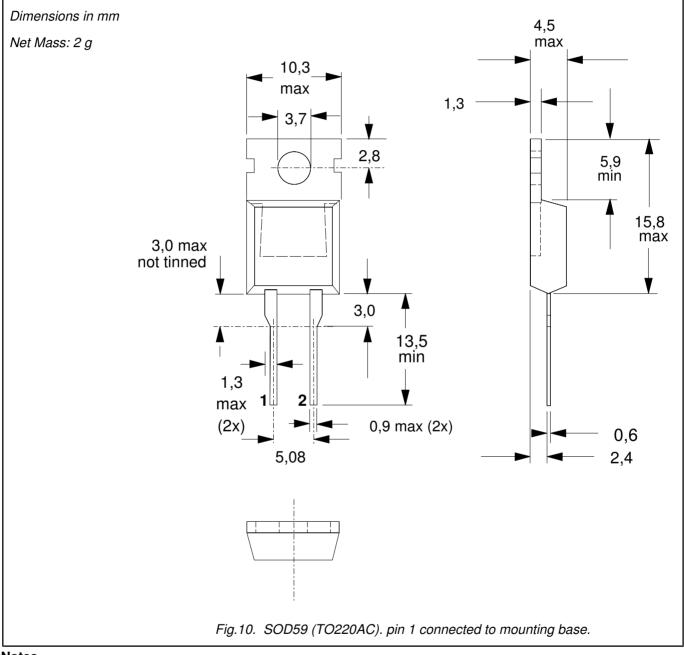
Rectifier diodes ultrafast



Rectifier diodes ultrafast

BYT79 series

MECHANICAL DATA



Refer to mounting instructions for TO220 envelopes.
Epoxy meets UL94 V0 at 1/8".

Legal information

DATA SHEET STATUS

DOCUMENT STATUS ⁽¹⁾	PRODUCT STATUS ⁽²⁾	DEFINITION
Objective data sheet	Development	This document contains data from the objective specification for product development.
Preliminary data sheet	Qualification	This document contains data from the preliminary specification.
Product data sheet	Production	This document contains the product specification.

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Customer notification

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Contact information

For additional information please visit: http://www.nxp.com For sales offices addresses send e-mail to: salesaddresses@nxp.com

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